

# Surface Mount Trench MOS Barrier Schottky Rectifier



## FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

## MECHANICAL DATA

**Case:** DO-221BC (SMPA)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test

**Polarity:** Color band denotes cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	3.0 A
$V_{RRM}$	50 V
$I_{FSM}$	80 A
$V_F$ at $I_F = 3.0$ A ( $T_A = 125$ °C)	0.40 V
$T_J$ max.	150 °C
Package	DO-221BC (SMPA)
Diode variation	Single die

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	V3PAN50	UNIT
Device marking code		3N5	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	V
Maximum DC forward current	$I_F^{(1)}$	3.0	A
Maximum DC reverse voltage	$V_{DC}$	35	V
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	80	A
Operating junction and storage temperature range	$T_J, T_{STG}$	- 40 to + 150	°C

### Note

(1) Free air, mounted on recommended copper pad area

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 1.5\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	0.40	-	V
	$I_F = 3.0\text{ A}$		0.47	0.54	
	$I_F = 1.5\text{ A}$	$T_A = 125\text{ }^\circ\text{C}$	0.30	-	
	$I_F = 3.0\text{ A}$		0.40	0.48	
Reverse current	$V_R = 35\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$	8	-	$\mu\text{A}$
			$T_A = 125\text{ }^\circ\text{C}$	8.8	-
	$V_R = 50\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$		-	600
			$T_A = 125\text{ }^\circ\text{C}$	12	35
Typical junction capacitance	4.0 V, 1 MHz	$C_J$		480	-

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
 (2) Pulse test: Pulse width  $\leq 5\text{ ms}$

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise specified)			
PARAMETER	SYMBOL	V3PAN50	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	100	$^\circ\text{C/W}$
	$R_{\theta JM}^{(1)}$	9	

**Note**

- (1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient;  $R_{\theta JM}$  - junction to mount

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V3PAN50-M3/I	0.032	I	14 000	13" diameter plastic tape and reel

**RATINGS AND CHARACTERISTICS CURVES**

( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

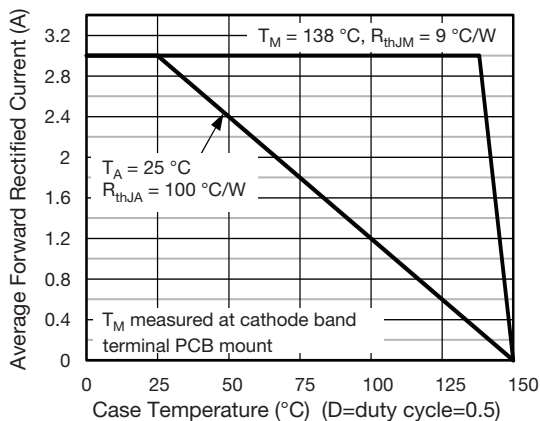


Fig. 1 - Maximum Forward Current Derating Curve

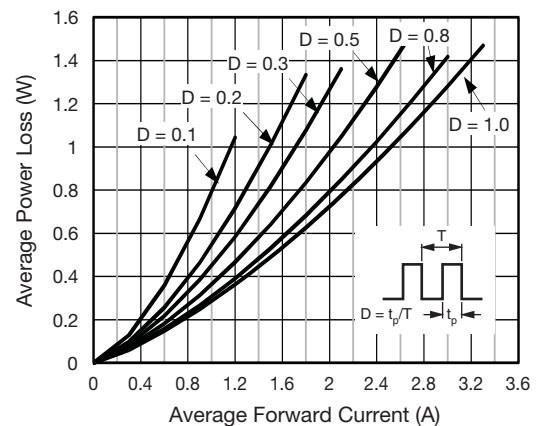


Fig. 2 - Forward Power Loss Characteristics

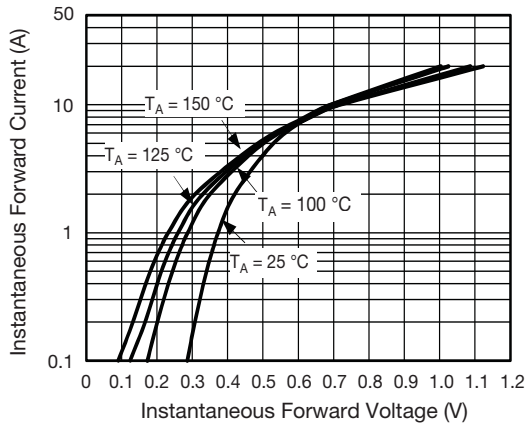


Fig. 3 - Typical Instantaneous Forward Characteristics

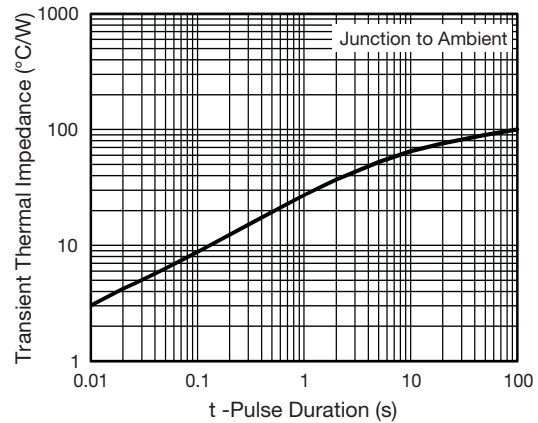


Fig. 6 - Typical Transient Thermal Impedance

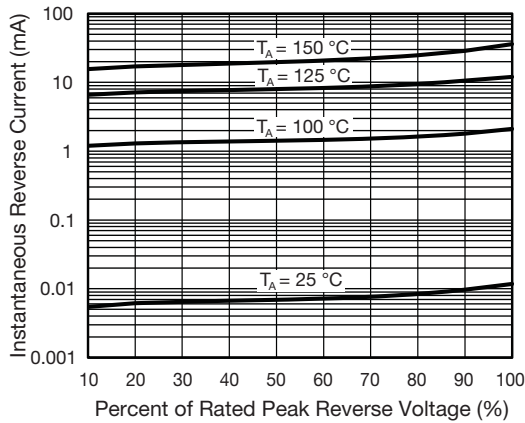


Fig. 4 - Typical Reverse Leakage Characteristics

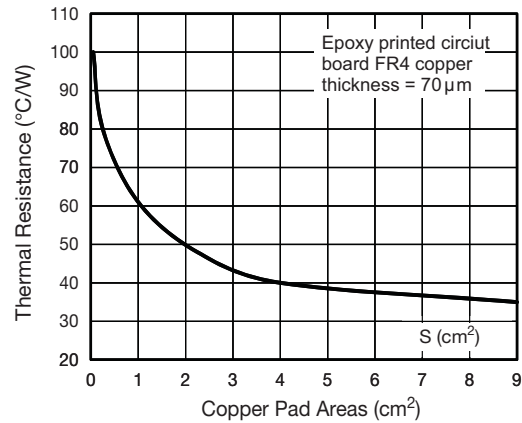


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

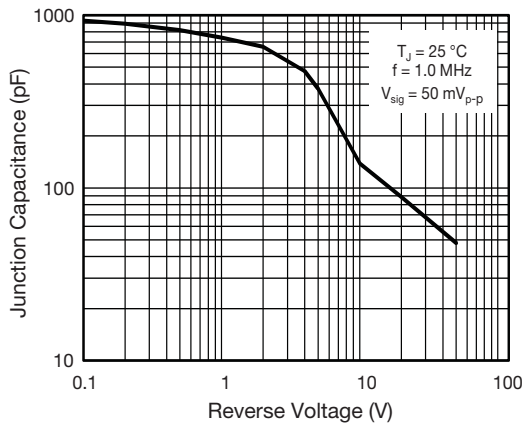
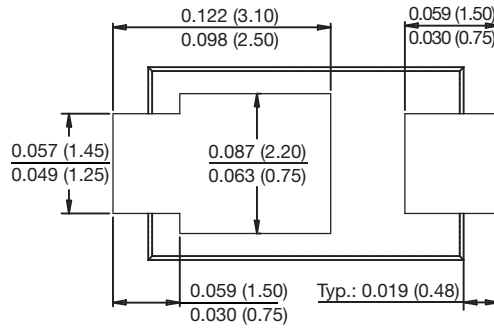
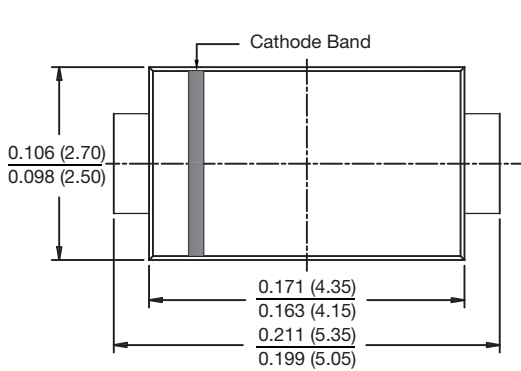


Fig. 5 - Typical Junction Capacitance

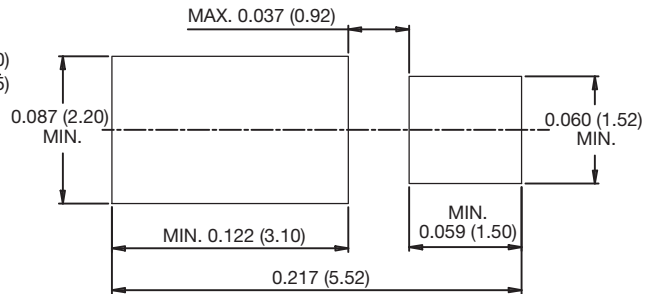
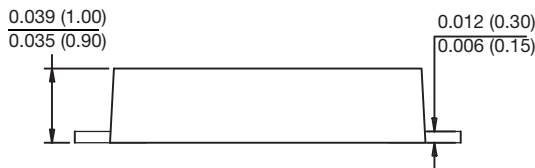


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-221BC (SMPA)



Mounting Pad Layout





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